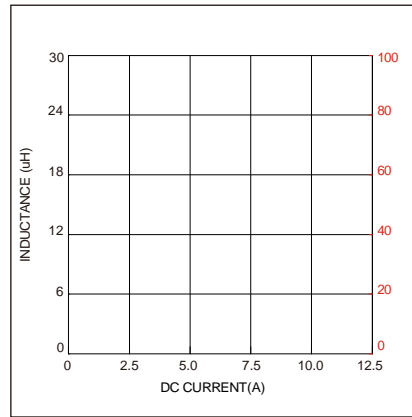
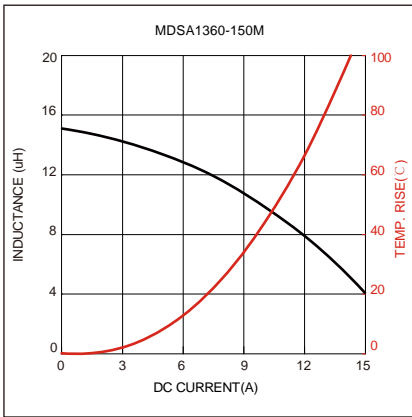
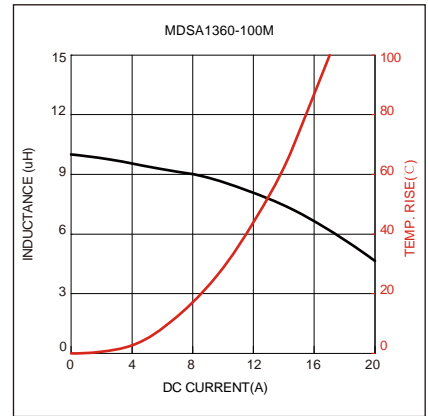
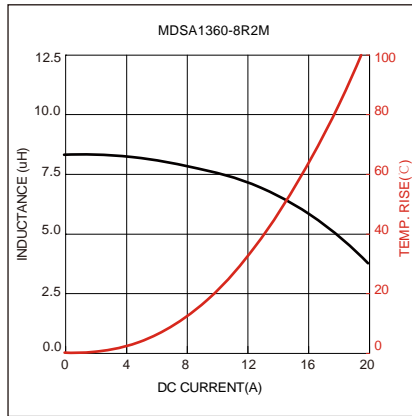
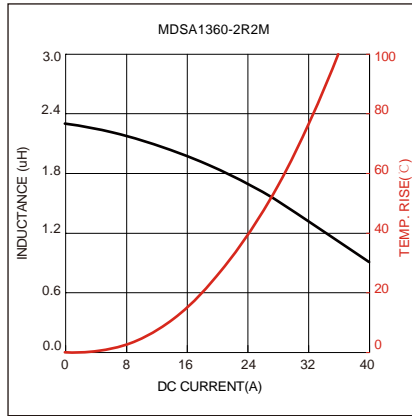
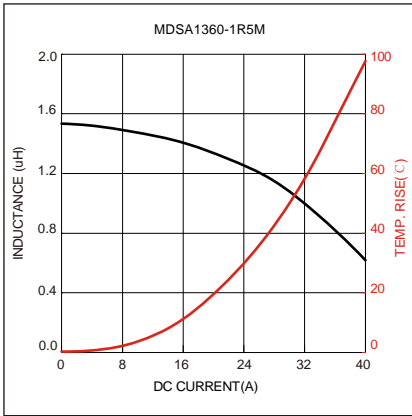
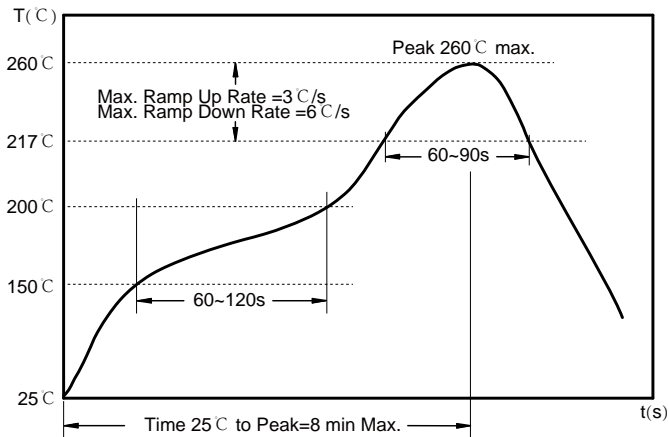


Typical Electrical Characteristics:



Soldering Reflow:



Preheat condition: 150 ~200°C / 60~120 sec.

Allowed time above 217°C: 60~90 sec.

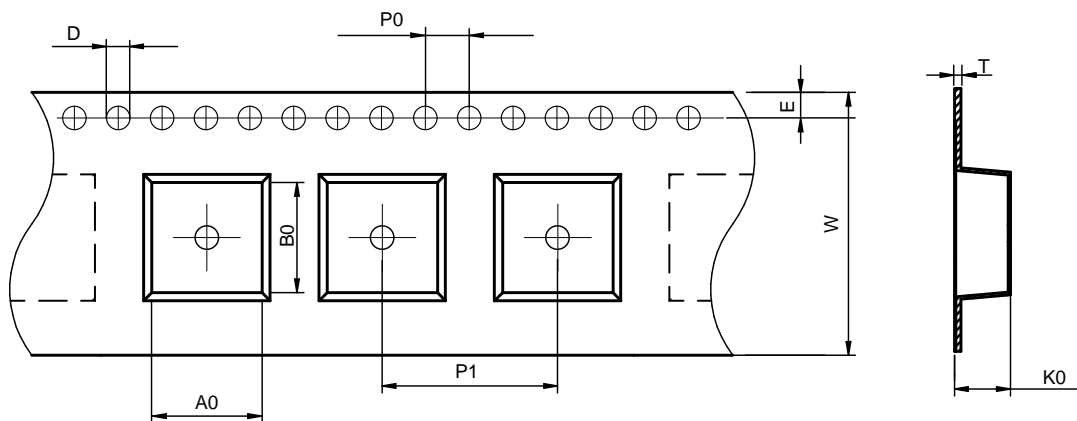
Max temperature: 260°C.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

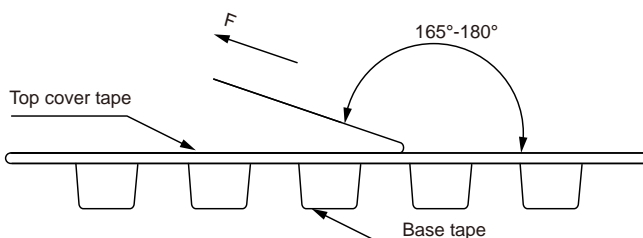
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDSA1360	13.1± 0.1	14.0± 0.1	1.5± 0.1	4.0± 0.1	16.0± 0.1	24.0± 0.3	6.3± 0.1	1.75± 0.1	0.50± 0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	KH+Printing Inductance)
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Reel Dimension: [mm]Cover type

Embossed Carrier

Packaging Quantity: